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IN THE CLAIMS:

Please amend the claims as follows:

Claims 1 and 2 (Cancelled)

Claim 3 (Currently Amended): The An organic electroluminescence display panel

according to claim 1, comprising:

a plurality of organic electroluminescence devices, each of which comprises first and

second display electrodes and an organic functional layer sandwiched and stacked between the

first and second display electrodes, the organic functional layer including at least a light emitting

layer comprising a single organic compound layer; and

a substrate supporting the plurality of organic electroluminescence devices,

wherein at least one of the first and second display electrodes comprises a common layer

formed in common with the plurality of organic electroluminescence devices and the common

layer comprises a low resistance region corresponding to the organic electroluminescence device

and a high resistance region connected to the low resistance region and having a higher

resistivity than the low resistance region,

wherein the high resistance region has a sheet resistance of $1 \times 10^6 \Omega / \Box$ or more.

Claim 4 (Cancelled)

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Claim 5 (Currently Amended): The organic electroluminescence display panel according

to claim ± 3 , wherein the difference in sheet resistance between the low resistance region and the

high resistance region is equal to or greater than two orders of magnitude.

Claim 6 (Currently Amended): The organic electroluminescence display panel according

to claim $\frac{1}{2}$, wherein the high resistance region contains at least one of oxygen and nitrogen as

an added ingredient, and has a higher content of at least one of oxygen and nitrogen than the low

resistance region.

Claim 7 (Currently Amended): The organic electroluminescence display panel according

to claim 4 3, wherein the high resistance region contains a donor or an acceptor and has a lower

content of the donor or acceptor than the low resistance region.

Claims 8 and 9 (Cancelled)

Claim 10 (Currently Amended): The fabricating method according to claim 9, A method

of fabricating an organic electroluminescence display panel, the organic electroluminescence

display panel comprising: a plurality of organic electroluminescence devices, each of which

comprises first and second display electrodes and an organic functional layer sandwiched and

stacked between the first and second display electrodes, the organic functional layer including at

least a light emitting layer comprising a single organic compound layer; and a substrate

supporting the plurality of organic electroluminescence devices, the method comprising the steps

<u>of:</u>

forming a common layer having conductivity; and

performing a resistance increasing process in which a high resistance region having a resistivity higher than the resistivity of the common layer is partially formed to define a low resistance region having a lower resistivity than the high resistance region, and the low resistance region is formed as at least one of the first and second display electrodes,

wherein the resistance increasing process step comprises a process for partially oxidizing or nitriding the common layer by placing the substrate in an oxygen or nitrogen atmosphere.

Claims 11 and 12 (Cancelled)

Claim 13 (Original): A method of fabricating an organic electroluminescence display panel, the organic electroluminescence display panel comprising: a plurality of organic electroluminescence devices, each of which comprises first and second display electrodes and an organic functional layer sandwiched and stacked between the first and second display electrodes, the organic functional layer including at least a light emitting layer comprising a single organic compound layer; and a substrate supporting the plurality of organic electroluminescence devices, the method comprising the steps of:

forming a common layer having a high resistance; and

performing a resistance decreasing process in which a low resistance region having a resistivity lower than the resistivity of the common layer is partially formed to define a high resistance region having a higher resistivity than the low resistance region, and the low resistance region is formed as at least one of the first and second display electrodes.

Claim 14 (Original): The fabricating method according to claim 13, wherein the

resistance decreasing process step comprises a process for partially reducing the common layer

by placing the substrate in a reduction atmosphere.

Claim 15 (Original): The fabricating method according to claim 13, wherein the

resistance decreasing process step comprises a process for partially doping the donor or acceptor.

Claim 16 (Cancelled)

Claim 17 (Original): A method of fabricating an organic electroluminescence display

panel, the organic electroluminescence display panel comprising: a plurality of organic

electroluminescence devices, each of which comprises first and second display electrodes and an

organic functional layer sandwiched and stacked between the first and second display electrodes,

the organic functional layer including at least a light emitting layer comprising a single organic

compound layer; and a substrate supporting the plurality of organic electroluminescence devices,

the method comprising the steps of:

forming a common layer having conductivity;

performing a resistance increasing process in which a high resistance region having a

resistivity higher than the resistivity of the common layer is partially formed to define a low

resistance region having a lower resistivity than the high resistance region; and

performing a resistance decreasing process in which a second low resistance region

having a resistivity lower than the resistivity of the common layer is partially formed in the low

resistance region, and the second low resistance region is formed as at least one of the first and

second display electrodes.

Claim 18 (Original): The fabricating method according to claim 17, wherein the

resistance increasing process step comprises a process for partially oxidizing or nitriding the

common layer by placing the substrate in an oxygen or nitrogen atmosphere.

Claim 19 (Original): The fabricating method according to claim 17, wherein the common

layer contains a donor or an acceptor, and the resistance increasing process step comprises a

process for partially undoping the donor or acceptor.

Claim 20 (Original): The fabricating method according to claim 17, wherein the common

layer has an amorphous or polycrystalline structure, and the resistance increasing process step

comprises a step of partially annealing the common layer in which a process for increasing an

amount of presence of the grain boundaries in the crystalline structure in comparison with the

low resistance region is performed.

Claim 21 (Original): The fabricating method according to claim 17, wherein the

resistance decreasing process step comprises a process for partially reducing the common layer

by placing the substrate in a reduction atmosphere.

Claim 22 (Original): The fabricating method according to claim 17, wherein the

resistance decreasing process step comprises a process for partially doping the donor or acceptor.

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Claim 23 (Original): The fabricating method according to claim 17, wherein the common layer has an amorphous or polycrystalline structure, and the resistance decreasing process step comprises a step of partially annealing the low resistance region in which a process for decreasing an amount of presence of the grain boundaries in the crystalline structure in comparison with the low resistance region is performed.